

CMOS CAMERA MODULES

your BEST camera module partner

KLT-IRSW-OV4682 V2.0 **OmniVision OV4682 with IR Switch MIPI Interfaz Foco fijo 4MP M12** Módulo de cámara

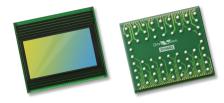


Módulo de cámara No.	KLT-IRSW-OV4682 V2.0	
Sensor de imagen	OV4682	IR SWITCH
EFL	3.1 mm	Input Voltage: 4V ~ 12V
F.NO	1.8	Operating Current: 88 ~ 300 mA
Pixel	2688 x 1520	Red Line: Positive
Ángulo de visión	140°	Black Line: Negative
Tipo de lente	1/3 pulgada	
Dimensiones de la lente	14.00 x 14.00 x 23.10 mm	Operation:
Tamaño del módulo	57.07 x 30.00 mm	ON: IR Active (Day Time)
Tipo de módulo	Foco fijo	OFF: IR Disable (Night Time)
Interfaz	MIPI	



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OV4682 4MP product brief



Dual-Purpose RGB IR CameraChip[™] Sensor Brings

High Sensitivity and High Frame Rates to Mobile

lead free

available in a lead-free package OmniVision's OV4682 is a 4-megapixel RGB infrared (IR) single sensor that captures high-resolution images and video as well as IR information. Its dual RGB and IR capabilities allow it to bring a host of additional features to mobile and machine vision applications, including gesture sensing, depth analysis, iris detection and eye tracking. By combining two capabilities into a single sensor, the OV4682 reduces the total cost for the system while also reducing the space required for multiple sensors.

and Machine Vision Applications

The sensor's 2-micron OmniBSI-2[™] pixel delivers excellent signal-to-noise ratio and IR sensitivity, and offers best-in-class low-light sensitivity with a 40 percent increase in sensitivity compared to the 1.75-micron OmniBSI-2 pixel. The OV4682's unique architecture and pixel optimization bring not only the best IR performance but also best-in-class image quality. Additionally, the sensor reduces system-level power consumption by optimizing RGB and IR timing.

The OV4682 records full-resolution 4-megapixel video in a native 16:9 format at 90 frames per second (fps), with a quarter of the pixels dedicated to capturing IR. The 1/3-inch sensor can also record 1080p high definition (HD) video at 120 fps with electronic image stabilization (EIS), or 720p HD at 180 fps.

The OV4682 features a high-speed 4-lane MIPI serial output interface to facilitate the required high data transfer rate. It fits into an 8.5 x 8.5 mm module with a z-height of less than 6 mm.

Find out more at www.ovt.com.





Applications

- Cellular Phones
- Tablets
- Digital Still Cameras (DSC)
- Digital Video Camcorders (DVC)
- PC Multimedia Security
- Gaming
- Gesture Detection

Product Features

- programmable controls for frame rate, mirror and flip, cropping, and windowing standard serial SCCB interface
- static defective pixel canceling
- supports output formats: 10-bit RAW RGB-IR (MIPI)
- supports horizontal and vertical subsampling
- supports images sizes: 4MP, 3MP, EIS1080p, 1080p, EIS720p
- fast mode switching

- automatic black level calibration (ABLC) support 2x2 binning, 4x4 binning, re-sampling filter

 - up to 4-lane MIPI serial output interface
 - embedded 4K bits one-time programmable (OTP) memory for part identification, etc.
 - two on-chip phase lock loops (PLLs)
 - programmable I/O drive capability
 - built-in temperature sensor

- OV04682-G04A-1D
- (RGB-IR, chip probing, 200 µm backgrinding, reconstructed wafer with good die)

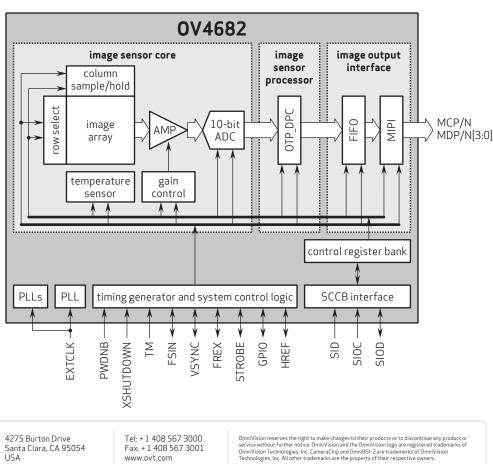
Product Specifications

- active array size: 2688 × 1520
- power supply:
 core: 1.1 1.3V
 analog: 2.6 3.0V
 I/O: 1.7 3.0V
- power requirements:
- active: 163 mA (261 mW) - standby: 1 mA - XSHUTDOWN: <10 µA
- temperature range:
 operating: -30°C to +85°C junction temperature - stable image: 0°C to +60°C junction temperature
- output formats: 10-bit RAW RGB data
- lens size: 1/3"
- input clock frequency: 6 64 MHz

lens chief ray angle: 21° non-linear

OV4682

- maximum image transfer rate:
 2688x1520: 90 fps - 1920x1080: 120 fps -1280x720:180 fps
 - 672x380: 330 fps
- scan mode: progressive
- maximum exposure interval: $1548 \times T_{ROW}$
- pixel size: 2 µm x 2 µm
- dark current: 4 mV/sec @ 60°C junction temperature
- image area: 5440 μm x 3072 μm
- die dimensions: COB: 6600 µm x 5800 µm RW: 6650 µm x 5850 µm





Version 2.2, October, 2014

Functional Block Diagram